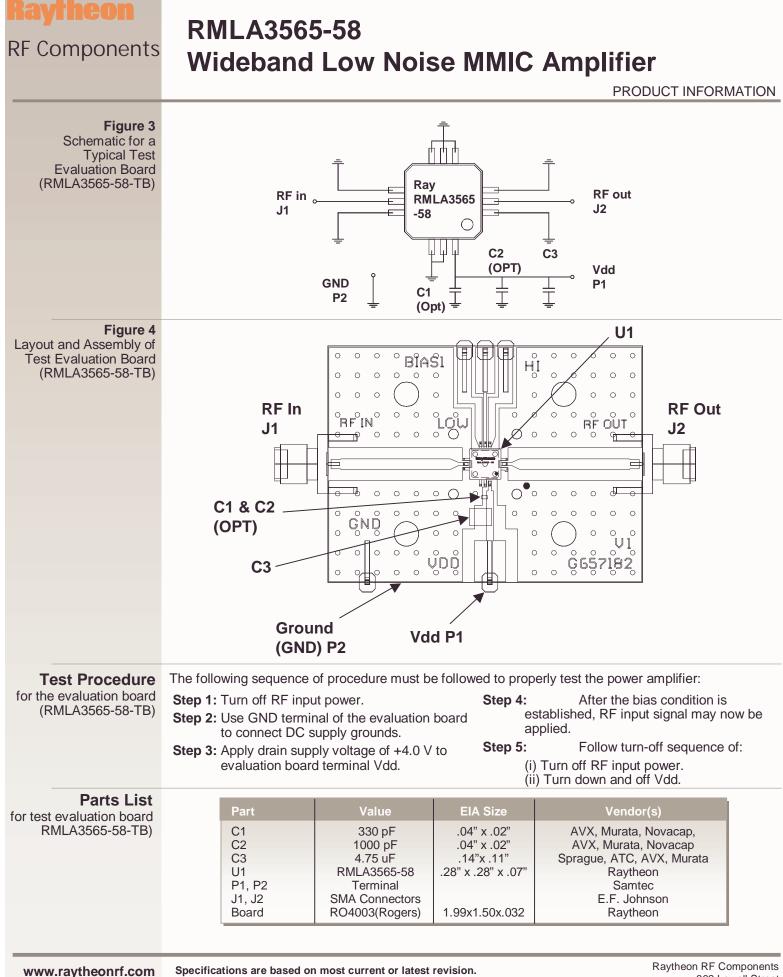
Raytheon RF Components	RMLA3565-58 Wideband Low Noi	se MMI(-		
Description	The Raytheon RF Components RMLA3565-58 is a single bias wideband low noise MMIC amplifier designed for the 3.5 - 6.5 GHz frequency range. The MMIC requires no external matching circuits or external gate bias supply. This device uses Raytheon's advanced 0.25 µm PHEMT process to provide low noise, high linearity, and low current.				
Features	 18.0 dB Gain typical 1.4 dB Noise Figure Typical 5.0 -6.5 GHz Single Positive Bias Small Outline Metal Base Quad Plastic Package Internal 50 Ω Matching 				
Absolute Ratings	ParameterPositive Drain DC VoltageRF Input Power (from 50Ω sourceDrain CurrentCase Operating TemperatureStorage Temperature RangeSoldering TemperatureThermal Resistance(Channel to Case)	Symbol V _{dd}) P _{IN} (CW) I _{dd} T _{case} T _{storage} T _{solder} R _{jc}	6.5 0 130 -35 to 85 -40 to 110 220	Unit V dBm mA °C °C °C °C	
Electrical Characteristics (50Ω System, V _{dd} = 4 V, T = +25°C)	ParameterMinTypMaxFrequency Range3.56.5Gain (Small Signal) ^{1,2} 17.018.0Gain Variation vs Temp0.013Noise Figure ² 3.5 - 5 GHz3.5 - 5 GHz2.05 - 6.5 GHz1.41.6	GHz dB dB/°C dB dB dB Hower IP3 @ Idd Vdd Input/0	neter Min Out, P-1dB 8.0 5.5GHz,-8dBm Pout 3.0 Dutput Return Loss	9.0 dBm 21.0 dBm 70 90 mA	

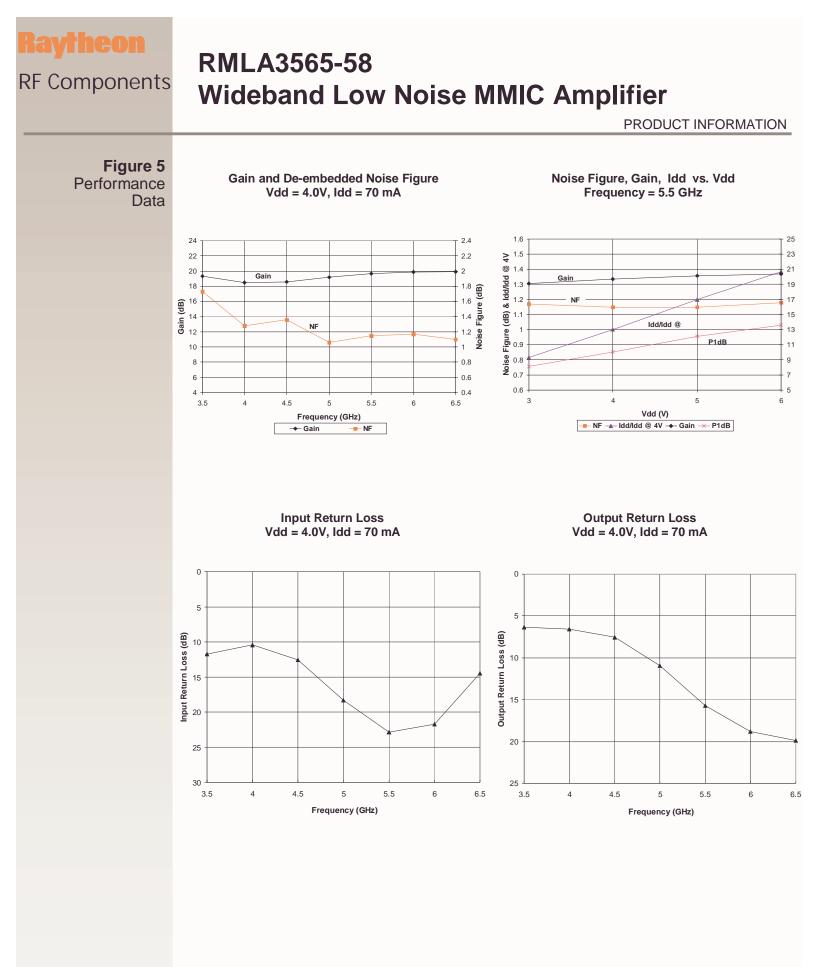
Raytheon RF Components	RMLA3565-58 Wideband Low Noise MMIC Amplifier PRODUCT INFORMATION			
Application	 CAUTION: THIS IS AN ESD SENSITIVE DEVICE The following briefly describes a procedure for evaluating the high efficiency PHEMT amplifier packaged in a surface mount package. It may be noted that the chip is a fully monolithic single ended two stage amplifier for 3.5 to 6.5 GHz applications. Figure 1 shows the functional block diagram of the packaged product. Test Fixture Figure 2 shows the outline and pin-out descriptions for the packaged device. A typical test fixture schematic showing external bias components is shown in Figure 3. Figure 4 shows typical layout of an evaluation board corresponding to the schematic diagram. Typical performance of the test fixture is shown in the performance data section. The following should be noted: Package pin designations are shown in figure 2. Vd is the drain voltage (positive) applied at the pins of the package. Vdd is the positive supply voltage at the evaluation board terminal. 			
Figure 1 Functional Block Diagram	Ground Pin# 5 Ground Pin# 1,3,4,6,9,10,11,13 Ground Pin# 7 RF IN Pin# 8 Vd Pin# 12			
Figure 2 Package Outline Dimensions	Dimensions in inches TOP VIEW 0.0200 SQ. 6 5 4 0.030 0.030 0.030 0.030 0.030 0.030 0.030 0.030 0.030 0.030 0.030 0.010 0.010 0.020 0.015			
www.raytheonrf.com	Specifications are based on most current or latest revision. Raytheon RF Components			



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